

RoHS

COMPLIANT

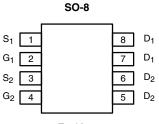
HALOGEN

FREE

**Vishay Siliconix** 

## Dual N-Channel 40 V (D-S) MOSFET

| PRODUCT SUMMARY     |                                  |                                 |                       |  |  |  |
|---------------------|----------------------------------|---------------------------------|-----------------------|--|--|--|
| V <sub>DS</sub> (V) | <b>R<sub>DS(on)</sub> (</b> Ω)   | I <sub>D</sub> (A) <sup>a</sup> | Q <sub>g</sub> (Typ.) |  |  |  |
| 40                  | 0.0325 at V <sub>GS</sub> = 10 V | 7                               | 3.3 nC                |  |  |  |
|                     | 0.040 at V <sub>GS</sub> = 4.5 V | 6.3                             | 3.3 110               |  |  |  |



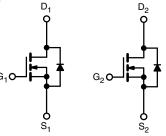
Top View

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 • Definition
- TrenchFET<sup>®</sup> Gen III Power MOSFET
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested •
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

- DC/DC Converter
- External HDD
- Notebook System F
- LCD Display Backlig



Ordering Information: Si4286DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET N-Channel MOSFET

| <b>ABSOLUTE MAXIMUM RATIN</b>                        | <b>IGS</b> (T <sub>A</sub> = 25 °C | , unless oth                      | erwise noted)        |      |
|--|------------------------------------|-----------------------------------|----------------------|------|
| Parameter  |                                    | Symbol                            | Limit                | Unit |
| Drain-Source Voltage                                 |                                    | V <sub>DS</sub>                   | 40                   | V    |
| Gate-Source Voltage                                  |                                    | V <sub>GS</sub>                   | ± 20                 | v    |
|  | T <sub>C</sub> = 25 °C             |                                   | 7                    |      |
| Continuous Drain Current (T 150 °C)                  | T <sub>C</sub> = 70 °C             | 1 .                               | 5.6                  |      |
| Continuous Drain Current ( $T_J = 150 \ ^{\circ}C$ ) | T <sub>A</sub> = 25 °C             | - I <sub>D</sub>                  | 5.7 <sup>b, c</sup>  |      |
|  | T <sub>A</sub> = 70 °C             |                                   | 4.6 <sup>b, c</sup>  | Α    |
| Pulsed Drain Current (t = 300 µs)                    |                                    | I <sub>DM</sub>                   | 20                   | A    |
|  | T <sub>C</sub> = 25 °C             |                                   | 2.4                  |      |
| Continuous Source-Drain Diode Current                | T <sub>A</sub> = 25 °C             | - I <sub>S</sub>                  | 1.6 <sup>b, c</sup>  |      |
| Single Pulse Avalanche Current                       |                                    | I <sub>AS</sub>                   | 8                    |      |
| Single Pulse Avalanche Energy                        | L = 0.1 mH                         | E <sub>AS</sub>                   | 3.2                  | mJ   |
|  | T <sub>C</sub> = 25 °C             | – P <sub>D</sub> –                | 2.9                  |      |
| Movimum Dower Discinction                            | T <sub>C</sub> = 70 °C             |                                   | 1.86                 | w    |
| Maximum Power Dissipation                            | T <sub>A</sub> = 25 °C             |                                   | 1.9 <sup>b, c</sup>  | vv   |
|  | T <sub>A</sub> = 70 °C             |                                   | 1.23 <sup>b, c</sup> |      |
| Operating Junction and Storage Temperature Range     |                                    | T <sub>J</sub> , T <sub>stg</sub> | - 55 to 150          | °C   |

| THERMAL RESISTANCE RATINGS                  |              |                   |         |         |      |  |  |
|---|--------------|-------------------|---------|---------|------|--|--|
| Parameter                                   |              | Symbol            | Typical | Maximum | Unit |  |  |
| Maximum Junction-to-Ambient <sup>b, d</sup> | t ≤ 10 s     | R <sub>thJA</sub> | 55      | 65      | °C/W |  |  |
| Maximum Junction-to-Foot (Drain)            | Steady State | R <sub>thJF</sub> | 35      | 43      | 0/11 |  |  |

Notes:

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under steady state conditions is 120 °C/W.

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| Parameter                                     | Symbol                  | Test Conditions   | Min. | Тур.    | Max.   | Unit  |  |
|---|-------------------------|---|------|---------|--------|-------|--|
| Static  |                         |   |      |         |        |       |  |
| Drain-Source Breakdown Voltage                | V <sub>DS</sub>         | $V_{GS} = 0, I_D = 250 \ \mu A$   | 40   |         |        | V     |  |
| V <sub>DS</sub> Temperature Coefficient       | $\Delta V_{DS}/T_{J}$   | L _ 250 uA  |      | 51      |        | mV/°C |  |
| V <sub>GS(th)</sub> Temperature Coefficient   | $\Delta V_{GS(th)}/T_J$ | I <sub>D</sub> = 250 μA   |      | - 5     |        |       |  |
| Gate-Source Threshold Voltage                 | V <sub>GS(th)</sub>     | $V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$   | 1.0  |         | 2.5    | V     |  |
| Gate-Source Leakage                           | I <sub>GSS</sub>        | $V_{DS} = 0 V$ , $V_{GS} = \pm 20 V$  |      |         | ± 100  | nA    |  |
| Zara Gata Valtaga Drain Current               | 1                       | $V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$   |      |         | 1      | μA    |  |
| Zero Gate Voltage Drain Current               | IDSS                    | $V_{DS}$ = 40 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C  |      |         | 10     |       |  |
| On-State Drain Current <sup>a</sup>           | I <sub>D(on)</sub>      | $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$   | 10   |         |        | Α     |  |
| Drain Course On State Desistence              | Б                       | $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 8 \text{ A}$  |      | 0.027   | 0.0325 | Ω     |  |
| Drain-Source On-State Resistance <sup>a</sup> | R <sub>DS(on)</sub>     | $V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 5 \text{ A}$   |      | 0.033   | 0.040  |       |  |
| Forward Transconductance <sup>a</sup>         | 9 <sub>fs</sub>         | $V_{DS} = 10 \text{ V}, \text{ I}_{D} = 8 \text{ A}$  |      | 27      |        | S     |  |
| Dynamic <sup>b</sup>                          |                         |   |      |         |        | •     |  |
| Input Capacitance                             | C <sub>iss</sub>        |   |      | 375     |        | pF    |  |
| Output Capacitance                            | C <sub>oss</sub>        | $V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$                                |      | 67      |        |       |  |
| Reverse Transfer Capacitance                  | C <sub>rss</sub>        |   |      | 29      |        |       |  |
| Total Gate Charge                             | Q <sub>g</sub> -        | $V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 8 \text{ A}$                               |      | 6.8 10. | 10.5   | nC    |  |
|   |                         |   |      | 3.3     | 5      |       |  |
| Gate-Source Charge                            | Q <sub>gs</sub>         | $V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 8 \text{ A}$            |      | 1       |        |       |  |
| Gate-Drain Charge                             | Q <sub>gd</sub>         |   |      | 1.1     |        |       |  |
| Gate Resistance                               | R <sub>g</sub>          | f = 1 MHz   | 0.8  | 3.7     | 7.4    | Ω     |  |
| Turn-On Delay Time                            | t <sub>d(on)</sub>      |   |      | 33      | 60     |       |  |
| Rise Time                                     | t <sub>r</sub>          | $V_{DD}$ = 20 V, $R_L$ = 2.5 $\Omega$   |      | 60      | 110    |       |  |
| Turn-Off Delay Time                           | t <sub>d(off)</sub>     | $I_D \cong 8 \text{ A}, V_{GEN} = 4.5 \text{ V}, \text{ R}_g = 1 \Omega$                        |      | 17      | 34     |       |  |
| Fall Time                                     | t <sub>f</sub>          |   |      | 22      | 40     |       |  |
| Turn-On Delay Time                            | t <sub>d(on)</sub>      |   |      | 9       | 18     | ns    |  |
| Rise Time                                     | t <sub>r</sub>          | $V_{DD}$ = 20 V, $R_L$ = 2.5 $\Omega$   |      | 11      | 22     | -     |  |
| Turn-Off Delay Time                           | t <sub>d(off)</sub>     | $I_D \cong 8 \text{ A}, V_{\text{GEN}} = 10 \text{ V}, \text{ R}_g = 1 \Omega$                  |      | 10      | 20     |       |  |
| Fall Time                                     | t <sub>f</sub>          |   |      | 7       | 14     |       |  |
| Drain-Source Body Diode Characteristi         | cs                      |   | •    |         |        | •     |  |
| Continuous Source-Drain Diode Current         | ۱ <sub>S</sub>          | T <sub>C</sub> = 25 °C  |      |         | 2.4    | •     |  |
| Pulse Diode Forward Current                   | I <sub>SM</sub>         |   |      |         | 20     | A     |  |
| Body Diode Voltage                            | V <sub>SD</sub>         | $I_{\rm S} = 3$ A, $V_{\rm GS} = 0$   |      | 0.8     | 1.2    | V     |  |
| Body Diode Reverse Recovery Time              | t <sub>rr</sub>         |   |      | 13      | 26     | ns    |  |
| Body Diode Reverse Recovery Charge            | Q <sub>rr</sub>         |   |      | 6       | 12     | nC    |  |
| Reverse Recovery Fall Time                    | t <sub>a</sub>          | $I_F = 5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 ^\circ\text{C}$ |      | 7       |        |       |  |
| Reverse Recovery Rise Time                    | t <sub>b</sub>          |   |      | 6       |        | ns    |  |

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

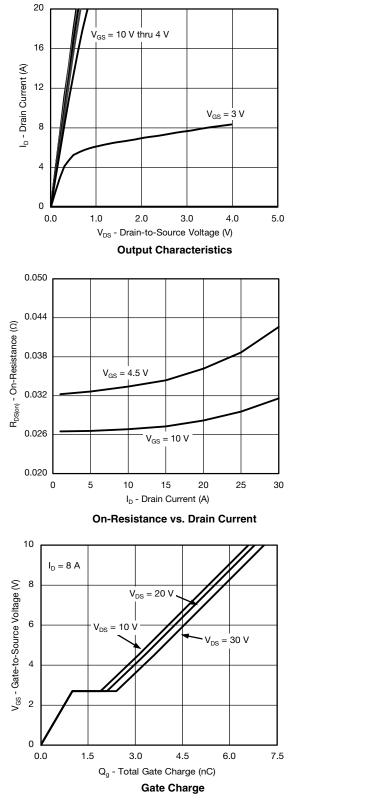
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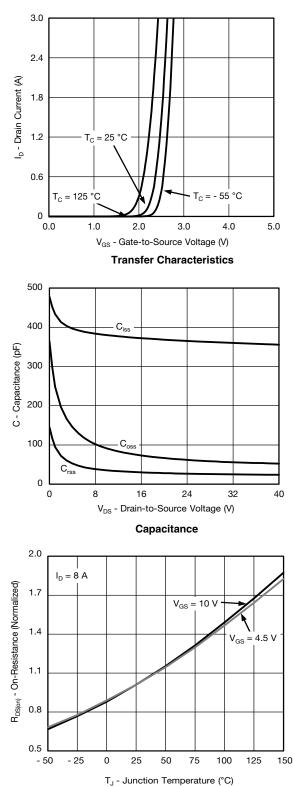
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Vishay Siliconix

#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





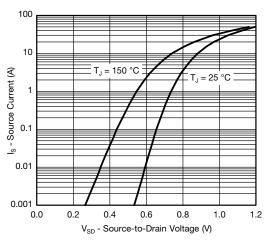
**On-Resistance vs. Junction Temperature** 

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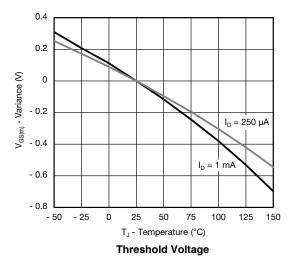
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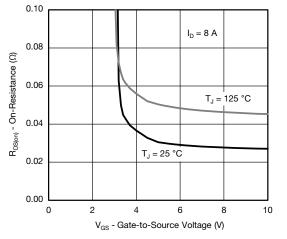


#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

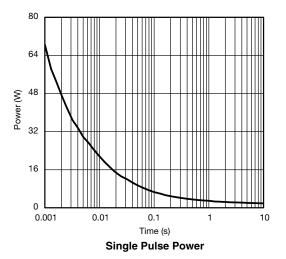


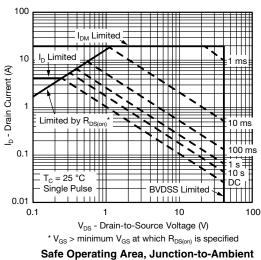






On-Resistance vs. Gate-to-Source Voltage





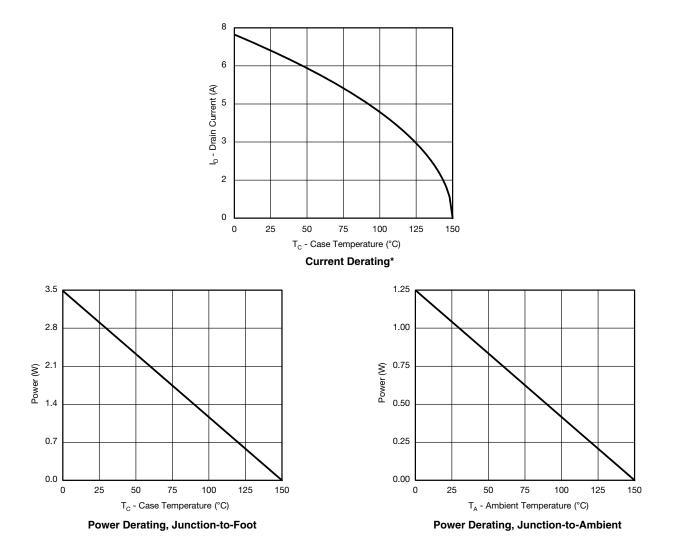
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Si4286DY Vishay Siliconix

#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



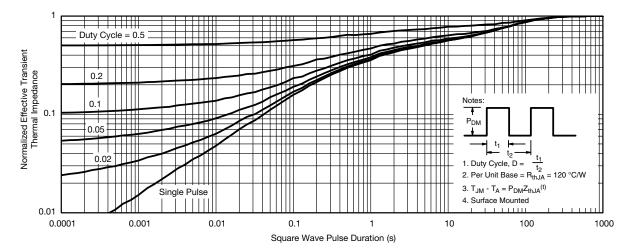
\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

5

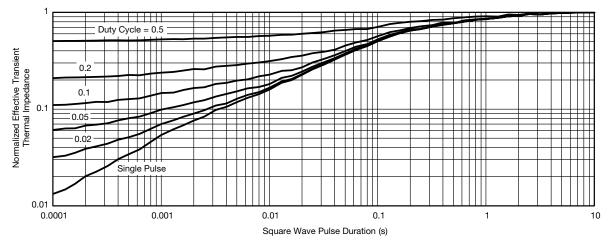


### Vishay Siliconix

#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?67599">www.vishay.com/ppg?67599</a>.

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## Package Information

Vishay Siliconix

# SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





|   | MILLIM | IETERS | INCHES    |       |  |
|---|--------|--------|-----------|-------|--|
| DIM   | Min    | Мах    | Min       | Max   |  |
| A   | 1.35   | 1.75   | 0.053     | 0.069 |  |
| A <sub>1</sub>                              | 0.10   | 0.20   | 0.004     | 0.008 |  |
| В   | 0.35   | 0.51   | 0.014     | 0.020 |  |
| С   | 0.19   | 0.25   | 0.0075    | 0.010 |  |
| D   | 4.80   | 5.00   | 0.189     | 0.196 |  |
| E   | 3.80   | 4.00   | 0.150     | 0.157 |  |
| е   | 1.27   | BSC    | 0.050 BSC |       |  |
| н   | 5.80   | 6.20   | 0.228     | 0.244 |  |
| h   | 0.25   | 0.50   | 0.010     | 0.020 |  |
| L   | 0.50   | 0.93   | 0.020     | 0.037 |  |
| q   | 0°     | 8°     | 0°        | 8°    |  |
| S   | 0.44   | 0.64   | 0.018     | 0.026 |  |
| ECN: C-06527-Rev. I, 11-Sep-06<br>DWG: 5498 |        |        |           |       |  |

## **Application Note 826**

Vishay Siliconix



**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

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